

**IRF710-713**  
**MTP2N35/2N40**  
**N-Channel Power MOSFETs,**  
**2.25 A, 350-400 V**

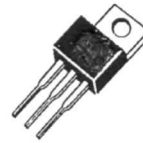
Power And Discrete Division

**Description**

These devices are n-channel, enhancement mode, power MOSFETs designed especially for high speed applications, such as switching power supplies, converters, AC and DC motor controls, relay and solenoid driver and high energy pulse circuits.

- Low  $R_{DS(on)}$
- $V_{GS}$  Rated at  $\pm 20$  V
- Silicon Gate for Fast Switching Speeds
- $I_{DSS}$ ,  $V_{DS(on)}$ , Specified at Elevated Temperature
- Rugged
- Low Drive Requirements
- Ease of Paralleling

TO-220AB



IRF710  
 IRF711  
 IRF712  
 IRF713  
 MTP2N35  
 MTP2N40

**Maximum Ratings**

Symbol	Characteristic	Rating IRF710/712 MTP2N40	Rating IRF711/713 MTP2N35	Unit
$V_{DSS}$	Drain to Source Voltage <sup>1</sup>	400	350	V
$V_{DGR}$	Drain to Gate Voltage <sup>1</sup> $R_{GS} = 20 \text{ k}\Omega$	400	350	V
$V_{GS}$	Gate to Source Voltage	$\pm 20$	$\pm 20$	V
$T_J, T_{stg}$	Operating Junction and Storage Temperatures	-55 to +150	-55 to +150	$^{\circ}\text{C}$
$T_L$	Maximum Lead Temperature for Soldering Purposes, 1/8" From Case for 5 s	275	275	$^{\circ}\text{C}$

**Maximum On-State Characteristics**

		IRF710-711	IRF712-713	MTP2N35/40	Unit
$R_{DS(on)}$	Static Drain-to-Source On Resistance	3.6	5.0	5.0	$\Omega$
$I_D$	Drain Current				A
	Continuous at $T_C = 25^{\circ}\text{C}$	1.5	1.4	1.3	
	Continuous at $T_C = 100^{\circ}\text{C}$	1.0	0.9	0.8	
	Pulsed	6.0	5.0	5.0	

**Maximum Thermal Characteristics**

					Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case	6.4	6.4	2.5	$^{\circ}\text{C}/\text{W}$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	80	80	80	$^{\circ}\text{C}/\text{W}$
$P_D$	Total Power Dissipation at $T_C = 25^{\circ}\text{C}$	20	20	50	W



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**IRF710-713**  
**MTP2N35/2N40**

**Electrical Characteristics** ( $T_C = 25^\circ\text{C}$  unless otherwise noted)

Symbol	Characteristic	Min	Max	Unit	Test Conditions
<b>Off Characteristics</b>					
$V_{(BR)DSS}$	Drain Source Breakdown Voltage <sup>1</sup> IRF710/712/MTP2N40 IRF711/713/MTP2N35			V	$V_{GS} = 0\text{ V}$ , $I_D = 250\ \mu\text{A}$
		400			
		350			
$I_{DSS}$	Zero Gate Voltage Drain Current		250	$\mu\text{A}$	$V_{DS} = \text{Rated } V_{DSS}$ , $V_{GS} = 0\text{ V}$
			1000	$\mu\text{A}$	$V_{DS} = 0.8 \times \text{Rated } V_{DSS}$ , $V_{GS} = 0\text{ V}$ , $T_C = 125^\circ\text{C}$
$I_{GSS}$	Gate-Body Leakage Current		$\pm 500$	nA	$V_{GS} = \pm 20\text{ V}$ , $V_{DS} = 0\text{ V}$
<b>On Characteristics</b>					
$V_{GS(th)}$	Gate Threshold Voltage IRF710-713 MTP2N35/2N40			V	$I_D = 250\ \mu\text{A}$ , $V_{DS} = V_{GS}$ $I_D = 1\text{ mA}$ , $V_{DS} = V_{GS}$
		2.0	4.0		
		2.0	4.5		
$R_{DS(on)}$	Static Drain-Source On-Resistance <sup>2</sup> IRF710/711 IRF712/713/MTP2N35/40			$\Omega$	$V_{GS} = 10\text{ V}$ , $I_D = 0.8\text{ A}$
			3.6		
			5.0		
$V_{DS(on)}$	Drain-Source On-Voltage <sup>2</sup> MTP2N35/2N40		13	V	$V_{GS} = 10\text{ V}$ , $I_D = 2.0\text{ A}$
			10	V	$V_{GS} = 10\text{ V}$ , $I_D = 1.0\text{ A}$ , $T_C = 100^\circ\text{C}$
$g_{fs}$	Forward Transconductance	0.5		S ( $\tau$ )	$V_{DS} = 10\text{ V}$ , $I_D = 0.8\text{ A}$
<b>Dynamic Characteristics</b>					
$C_{iss}$	Input Capacitance		200	pF	$V_{DS} = 25\text{ V}$ , $V_{GS} = 0\text{ V}$ $f = 1.0\text{ MHz}$
$C_{oss}$	Output Capacitance		50	pF	
$C_{rss}$	Reverse Transfer Capacitance		15	pF	
<b>Switching Characteristics</b> ( $T_C = 25^\circ\text{C}$ , Figures 11, 12) <sup>3</sup>					
$t_{d(on)}$	Turn-On Delay Time		10	ns	$V_{DD} = 200\text{ V}$ , $I_D = 0.8\text{ A}$ $V_{GS} = 10\text{ V}$ , $R_{GEN} = 50\ \Omega$ $R_{GS} = 50\ \Omega$
$t_r$	Rise Time		20	ns	
$t_{d(off)}$	Turn-Off Delay Time		10	ns	
$t_f$	Fall Time		15	ns	
$Q_g$	Total Gate Charge		7.5	nC	$V_{GS} = 10\text{ V}$ , $I_D = 2.0\text{ A}$ $V_{DD} = 200\text{ V}$

# IRF710-713 MTP2N35/2N40

## Electrical Characteristics (Cont.) ( $T_C = 25^\circ\text{C}$ unless otherwise noted)

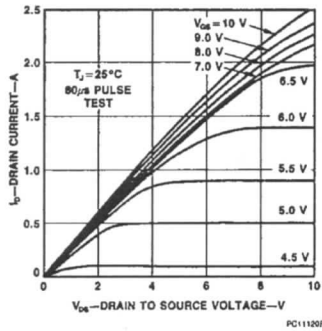
Symbol	Characteristic	Typ	Max	Unit	Test Conditions
<b>Source-Drain Diode Characteristics</b>					
$V_{SD}$	Diode Forward Voltage				
	IRF710/711		1.6	V	$I_S = 1.5 \text{ A}; V_{GS} = 0 \text{ V}$
	IRF712/713		1.5	V	$I_S = 1.3 \text{ A}; V_{GS} = 0 \text{ V}$
$t_{rr}$	Reverse Recovery Time	380		ns	$I_S = 1.5 \text{ A}; dI_S/dt = 25 \text{ A}/\mu\text{s}$

**Notes**

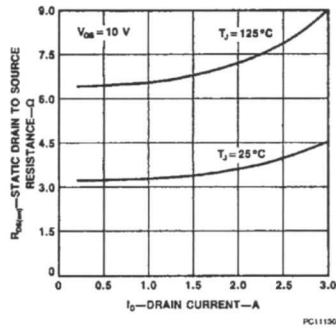
- $T_J = +25^\circ\text{C}$  to  $+150^\circ\text{C}$
- Pulse test: Pulse width  $\leq 80 \mu\text{s}$ , Duty cycle  $\leq 1\%$
- Switching time measurements performed on LEM TR-58 test equipment.

### Typical Performance Curves

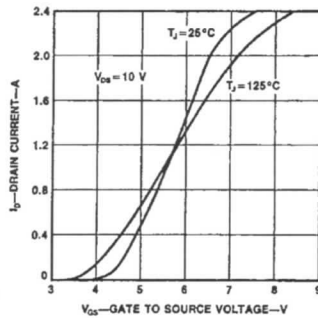
**Figure 1 Output Characteristics**



**Figure 2 Static Drain to Source Resistance vs Drain Current**



**Figure 3 Transfer Characteristics**



**Figure 4 Temperature Variation of Gate to Source Threshold Voltage**

